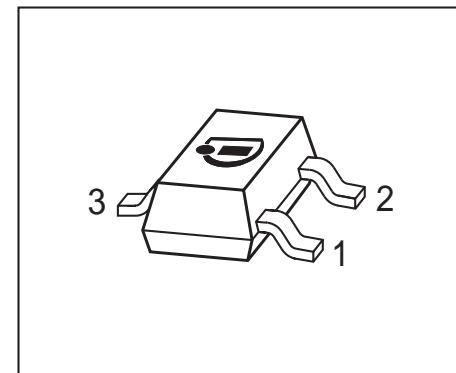


## PNP Silicon Darlington Transistors

- For general AF applications
- High collector current
- High current gain
- Complementary types: BCV27, BCV47 (NPN)
- Pb-free (RoHS compliant) package<sup>1)</sup>
- Qualified according AEC Q101



Type	Marking	Pin Configuration			Package
BCV26	FDs	1=B	2=E	3=C	SOT23
BCV46	FEs	1=B	2=E	3=C	SOT23

## Maximum Ratings

Parameter	Symbol	Value	Unit
Collector-emitter voltage BCV26	$V_{CEO}$	30	V
BCV46		60	
Collector-base voltage BCV26	$V_{CBO}$	40	
BCV46		80	
Emitter-base voltage	$V_{EBO}$	10	
Collector current	$I_C$	500	mA
Peak collector current	$I_{CM}$	800	
Base current	$I_B$	100	
Peak base current	$I_{BM}$	200	
Total power dissipation- $T_S \leq 74^\circ\text{C}$	$P_{tot}$	360	mW
Junction temperature	$T_J$	150	$^\circ\text{C}$
Storage temperature	$T_{stg}$	-65 ... 150	

<sup>1</sup>Pb-containing package may be available upon special request

**Thermal Resistance**

Parameter	Symbol	Value	Unit
Junction - soldering point <sup>1)</sup>	$R_{thJS}$	$\leq 210$	K/W

<sup>1)</sup>For calculation of  $R_{thJA}$  please refer to Application Note Thermal Resistance

**Electrical Characteristics** at  $T_A = 25^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
<b>DC Characteristics</b>					
Collector-emitter breakdown voltage $I_C = 10 \text{ mA}, I_B = 0$ , BCV26 $I_C = 10 \text{ mA}, I_B = 0$ , BCV46	$V_{(\text{BR})\text{CEO}}$	30 60	- -	- -	V
Collector-base breakdown voltage $I_C = 100 \mu\text{A}, I_E = 0$ , BCV26 $I_C = 100 \mu\text{A}, I_E = 0$ , BCV46	$V_{(\text{BR})\text{CBO}}$	40 80	- -	- -	
Emitter-base breakdown voltage $I_E = 10 \mu\text{A}, I_C = 0$	$V_{(\text{BR})\text{EBO}}$	10	-	-	
Collector-base cutoff current $V_{CB} = 30, I_E = 0$ , BCV26 $V_{CB} = 60, I_E = 0$ , BCV46 $V_{CB} = 30, I_E = 0, T_A = 150^\circ\text{C}$ , BCV26 $V_{CB} = 60, I_E = 0, T_A = 150^\circ\text{C}$ , BCV46	$I_{\text{CBO}}$	- - - -	- - - -	0.1 0.1 10 10	$\mu\text{A}$
Emitter-base cutoff current $V_{EB} = 4 \text{ V}, I_C = 0$	$I_{\text{EBO}}$	-	-	100	nA
DC current gain <sup>1)</sup> $I_C = 100 \mu\text{A}, V_{CE} = 1 \text{ V}$ , BCV26 $I_C = 100 \mu\text{A}, V_{CE} = 1 \text{ V}$ , BCV46 $I_C = 10 \text{ mA}, V_{CE} = 5 \text{ V}$ , BCV26 $I_C = 10 \text{ mA}, V_{CE} = 5 \text{ V}$ , BCV46 $I_C = 100 \text{ mA}, V_{CE} = 5 \text{ V}$ , BCV26 $I_C = 100 \text{ mA}, V_{CE} = 5 \text{ V}$ , BCV46 $I_C = 0.5 \text{ A}, V_{CE} = 5 \text{ V}$ , BCV26 $I_C = 0.5 \text{ A}, V_{CE} = 5 \text{ V}$ , BCV46	$h_{\text{FE}}$	4000 2000 10000 4000 20000 10000 4000 2000	- - - - - - - -	- - - - - - - -	-
Collector-emitter saturation voltage <sup>1)</sup> $I_C = 100 \text{ mA}, I_B = 0.1 \text{ mA}$	$V_{\text{CEsat}}$	-	-	1	V
Base emitter saturation voltage <sup>1)</sup> $I_C = 100 \text{ mA}, I_B = 0.1 \text{ mA}$	$V_{\text{BEsat}}$	-	-	1.5	

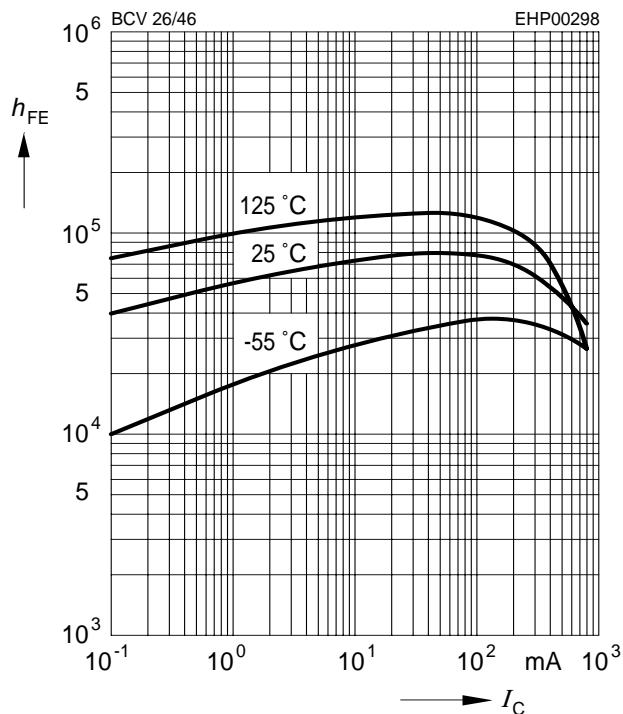
<sup>1</sup>Pulse test:  $t < 300\mu\text{s}$ ;  $D < 2\%$

**Electrical Characteristics at  $T_A = 25^\circ\text{C}$ , unless otherwise specified**

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
<b>AC Characteristics</b>					
Transition frequency $I_C = 50 \text{ mA}, V_{CE} = 5 \text{ V}, f = 100 \text{ MHz}$	$f_T$	-	200	-	MHz
Collector-base capacitance $V_{CB} = 10 \text{ V}, f = 1 \text{ MHz}$	$C_{cb}$	-	4.5	-	pF

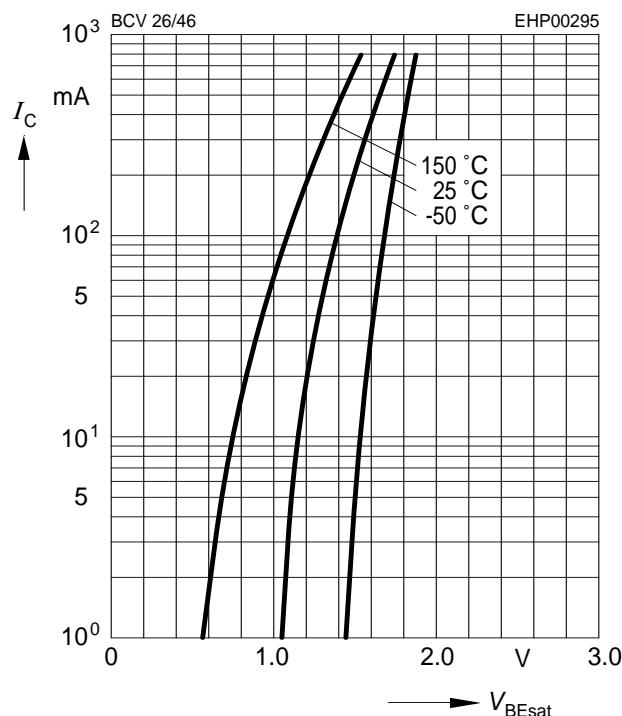
**DC current gain  $h_{FE} = f(I_C)$**

$$V_{CE} = 5 \text{ V}$$



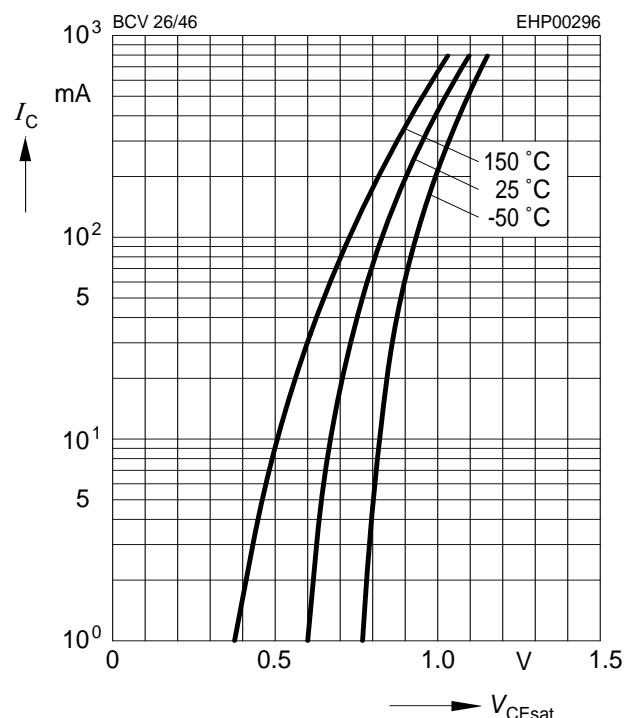
**Base-emitter saturation voltage**

$$I_C = f(V_{BEsat}), h_{FE} = 1000$$



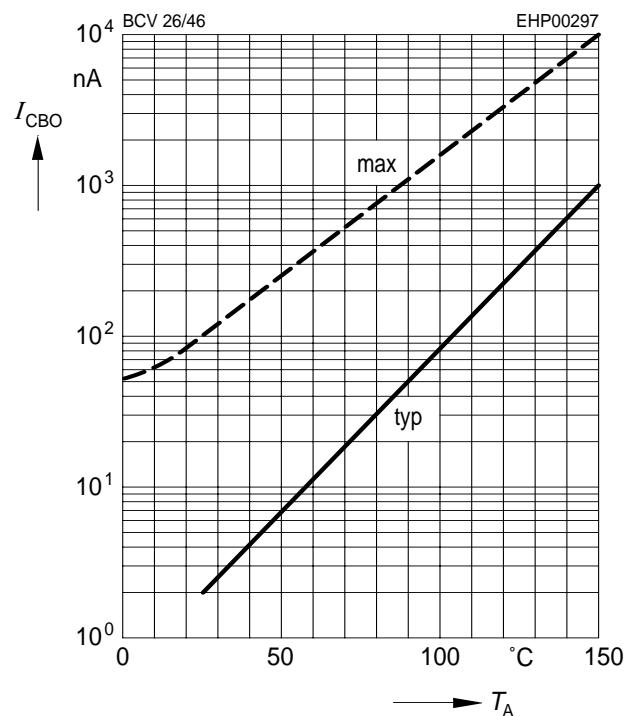
**Collector-emitter saturation voltage**

$$I_C = f(V_{CEsat}), h_{FE} = 1000$$

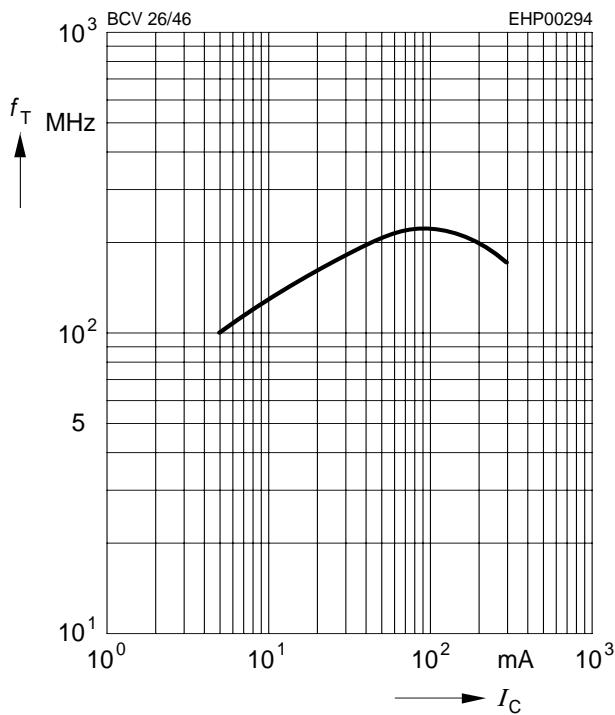


**Collector cutoff current  $I_{CBO} = f(T_A)$**

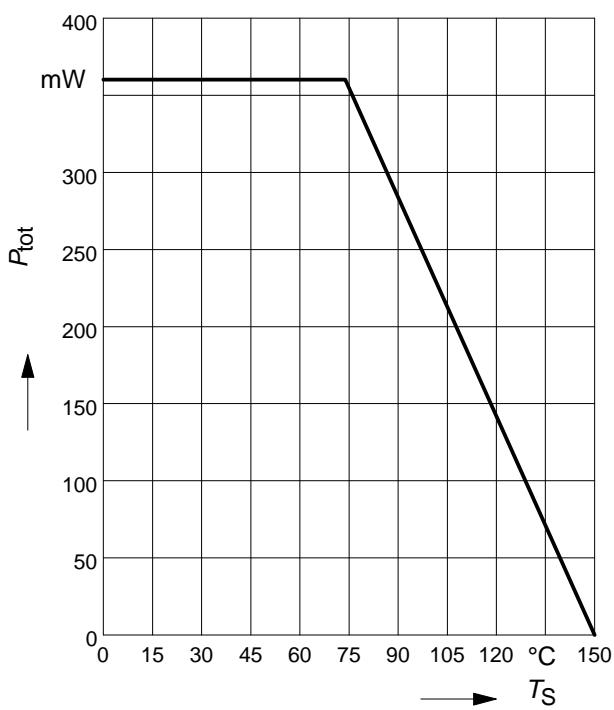
$$V_{CB} = V_{CEmax}$$



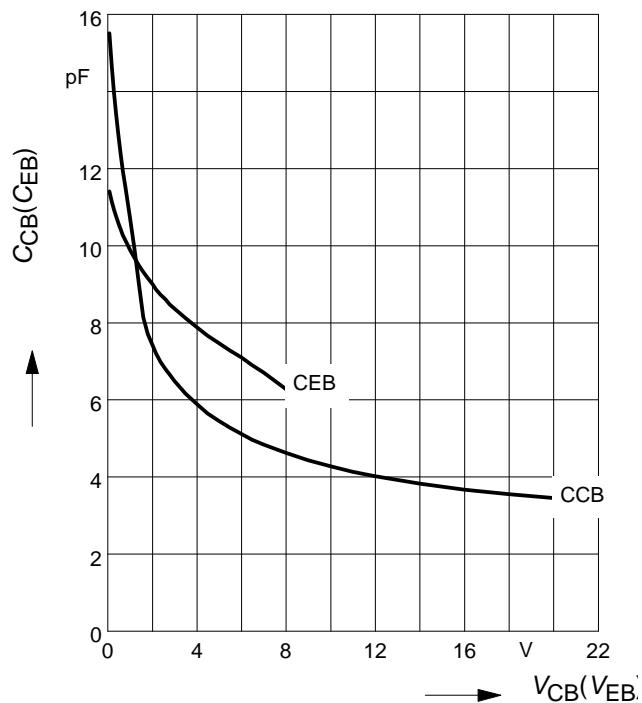
**Transition frequency**  $f_T = f(I_C)$   
 $V_{CE} = 5 \text{ V}$



**Total power dissipation**  $P_{\text{tot}} = f(T_S)$

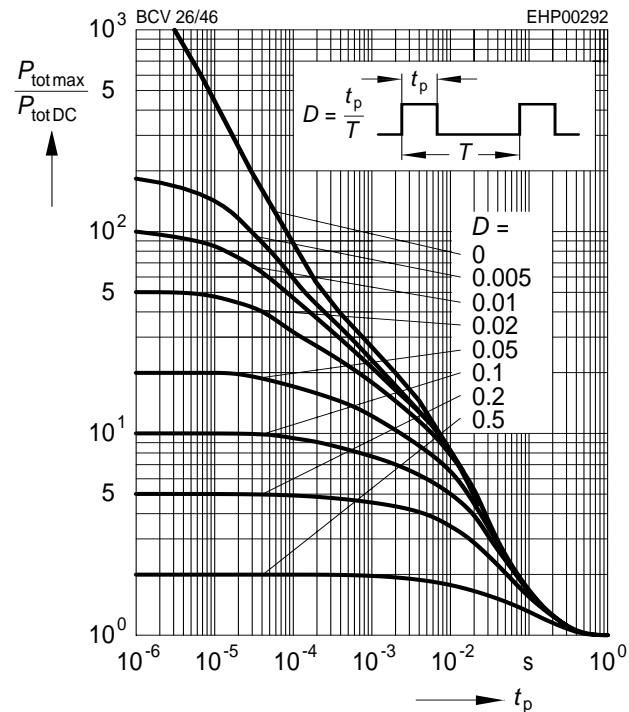


**Collector-base capacitance**  $C_{cb} = f(V_{CB})$   
**Emitter-base capacitance**  $C_{eb} = f(V_{EB})$

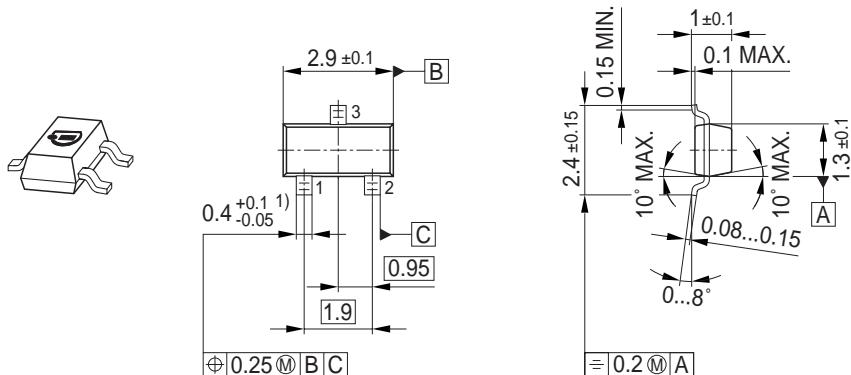


**Permissible Pulse Load**

$$P_{\text{totmax}}/P_{\text{totDC}} = f(t_p)$$

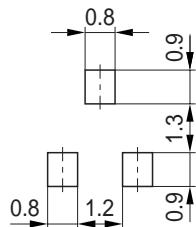


## Package Outline

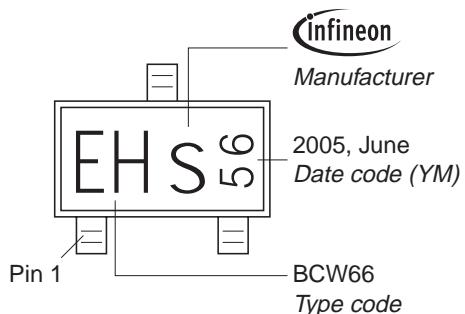


1) Lead width can be 0.6 max. in dambar area

## Foot Print

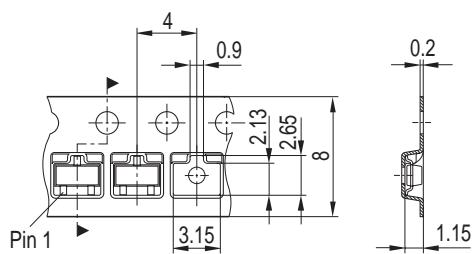


## Marking Layout (Example)



## Standard Packing

Reel ø180 mm = 3.000 Pieces/Reel  
Reel ø330 mm = 10.000 Pieces/Reel



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